

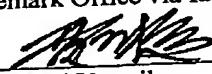
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SEP 12 2005

## Certificate of Facsimile Transmission

I hereby certify that the attached Transmittal (1 page), Response to the Office Action dated June 14, 2005 (7 pages), PTO form 2038 authorizing credit card payment of \$200.00 for additional claim fee are submitted to the U.S. Patent and Trademark Office via facsimile number 571-273-8300 on the date shown below. (Total 9 pages).

  
 Li Mei Vermilya

Date: September 12, 2005

 PATENT APPLICATION  
 Attorney Docket No. 9903-071  
 Client Ref. No. S02US035

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Jin-Hyuk LEE, et al.

Serial No.:	10/690,782	Examiner:	Graybill, David E.
Filed:	October 21, 2003	Group Art Unit:	2822
Confirmation No.:	5611		
For:	METHOD FOR MANUFACTURING A WAFER LEVEL CHIP SCALE PACKAGE		

 MAIL STOP AMENDMENT  
 Commissioner for Patents  
 P.O. Box 1450  
 Alexandria, VA 22313-1450

Responsive to the Final Office Action dated June 14, 2005, enclosed is an amendment in the above-identified application.

The fee has been calculated as shown below.

<u>CLAIMS AS AMENDED</u>					
For:	Number After Amendment	Previous Number	Extra	Rate	Additional Fee
Total Claims	19	17	0	x \$50 =	\$0
Independent Claims	4	3	1	x \$200 =	\$200
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					

\*greater of twenty (20) or number for which fee has been paid

\*\*greater of three (3) or number for which fee has been paid

PTO Form 2038 authorizing credit card payment for the above-listed fees is enclosed.  
 Any deficiency or overpayment should be charged or credited to deposit account number 13-1703.

Customer No. 20575

 Respectfully submitted,  
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Mail Stop Amendment  
 Commissioner for Patents  
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## AMENDMENT

Responsive to the Office Action, Paper No. 20050608, dated June 14, 2005, please amend the application as follows.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 6 of this paper.

09/13/2005 MBINAS 00000035 10690782  
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Docket No. 9903-071

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Application No. 10/690,782